

PG- GROUP

Exploiting commercial CMOS technologies for:

- detection of Minimum Ionizing Particles for High Energy Physics experiments
- direct detection of X-rays for medical applications

People:

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Felloship: L. Bissi^(2,1)

Students



(1) Istituto Nazionale di Fisica Nucleare
Sezione di Perugia

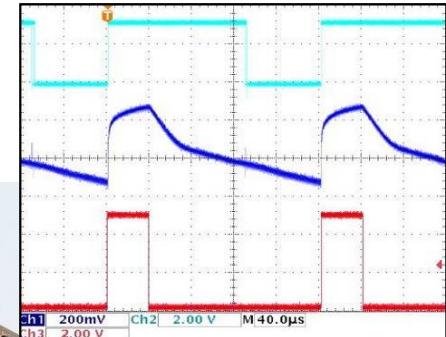
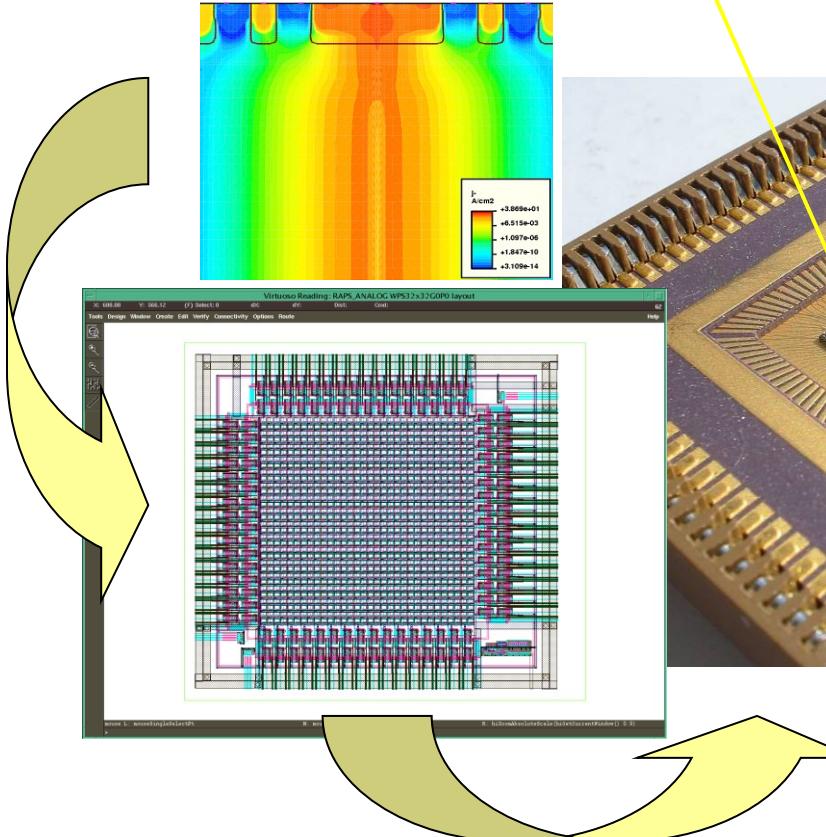


(2) Dipartimento di Ingegneria Elettronica e dell'Informazione
Università degli Studi di Perugia

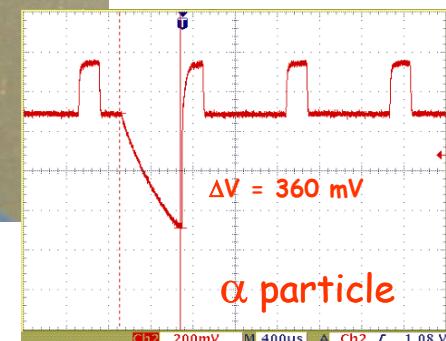
Activity (1)

Radiation Active Pixel Sensors

Geant 4 → Synopsys Advanced TCAD -> Cadence



Visible Light



Activity (2)

13 years of experience in radiation damage due
to the collaboration with the AMS experiment
and private companies



Projects (custom design)

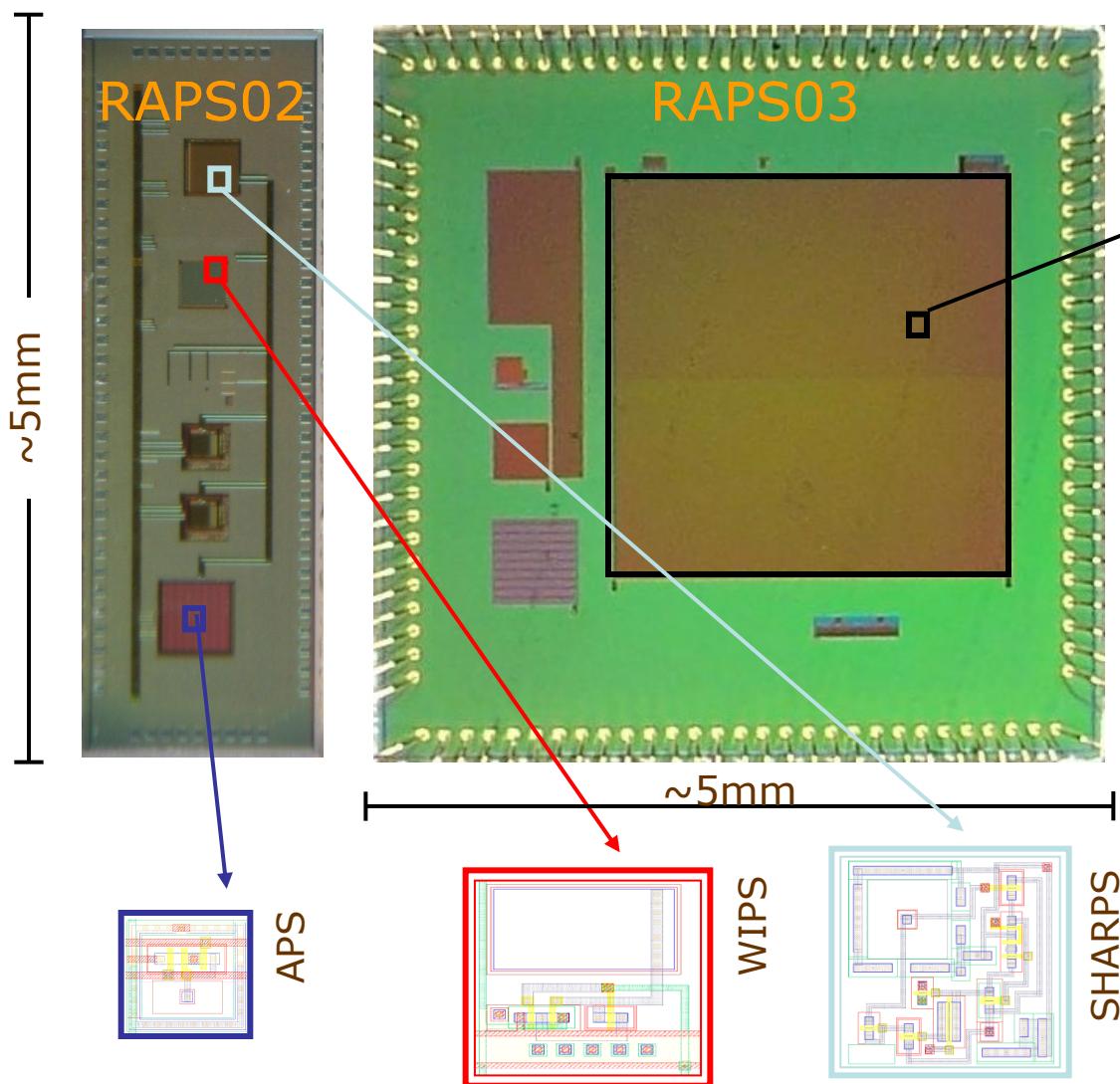
2001 – 2004: Radiation Active Pixel Sensors (RAPS) *Partners*: Univ. of Perugia, Univ. of Parma e INFN di Perugia

2005 – 2008: Self-resetting High-gain Active Radiation Pixel Sensor (SHARPS)
Partners: Univ. of Perugia, Univ. of Parma e INFN di Perugia

2009 – 2011: **VERTICAL SCALE INTEGRATION – PIXEL CMOS (VIPIX)**
Partners: SLIM5 – PI, PV, BG, BO, TO / DIGIMAPS – RM3 / SHARPS PG-PR

2009 – 2011: **To ASIC**
Partners: (INFN-Sez. di Catania, INFN-Sez. di Cagliari, INFN-Sez. di Perugia, Univ. of Perugia, Univ. of Parma)

Background



RAPS02

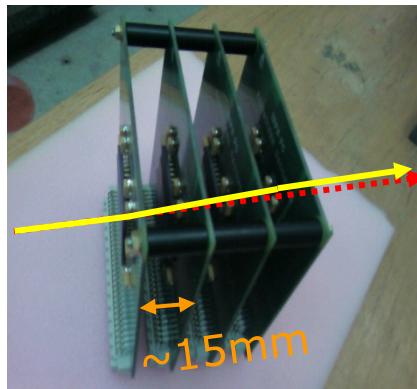
- UMC 0.18 μ m 1P6M CMOS
- 3T architecture 4x4 μ m², 10x10 μ m² pixel size
- sparse read-out prone
- in-pixel high-gain
- self-reset mode (event-triggered).

RAPS03

- 256x256 pixels
- 10x10 μ m² pixel size

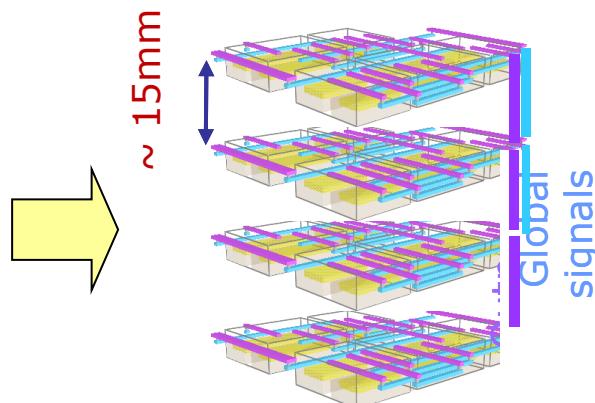
.... we're working on

1) What we have

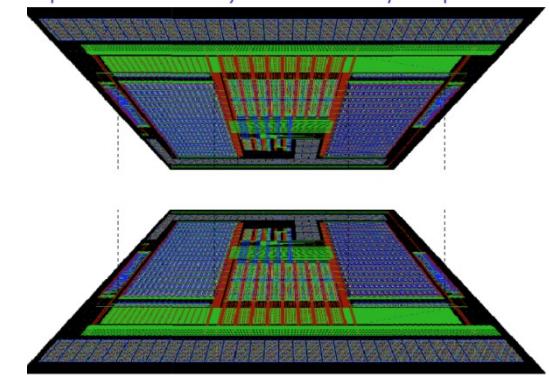


UMC 180nm

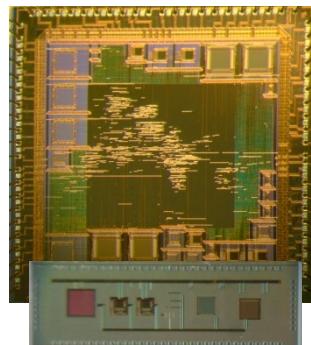
..... and what we would like to have!



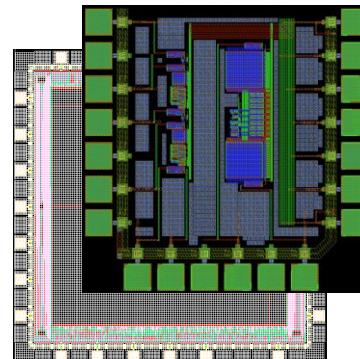
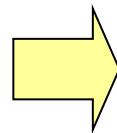
Chartered 130nm



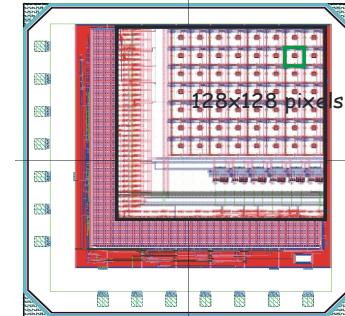
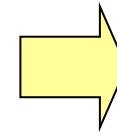
2) looking forward deep submicron technology



UMC 180nm



Chartered 130nm



UMC 90nm

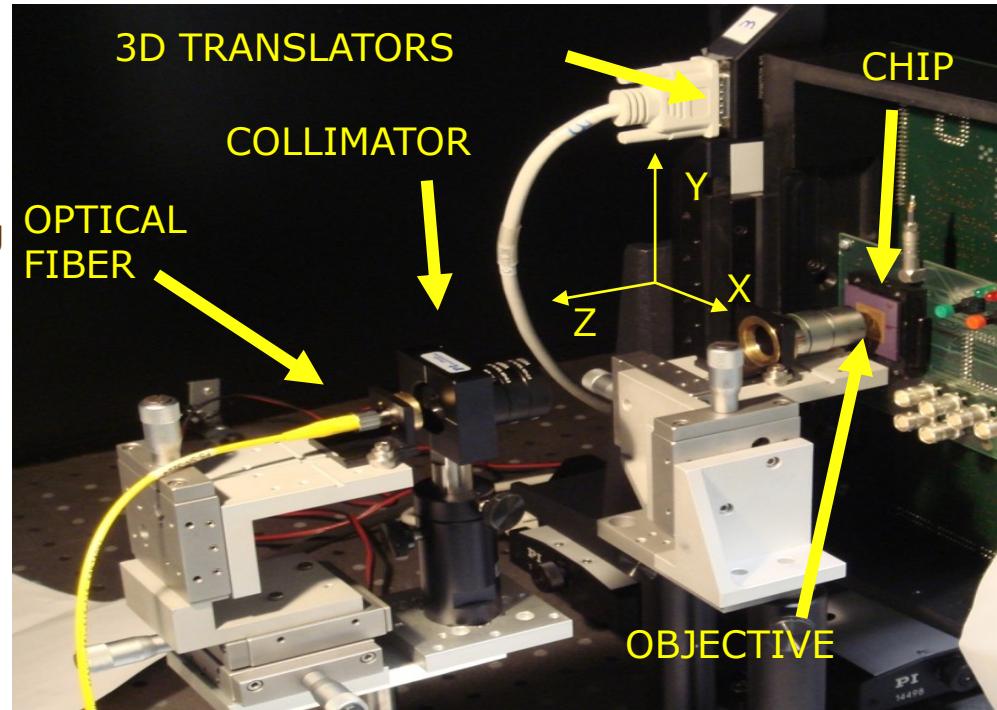
Facilities (1)

Software Equipment

- Cadence Combined IC and Systems Package, Calibre, MultiSim, Synopsys Advanced TCAD, ISE- Foundation (Xilinx)

Technological Facilities

- Optical bench
 - different laser heads
 - laser spot characterization: photon rate, intensity, focusing capability ($\sim 1\text{-}2\mu\text{m}$, single pixel hit)
 - advanced movement and DAQ capabilities: micropositioning
 - GUI: calibration, remote data acquisition , analysis (single pixel response, surface mapping, cross-talk)



Facilities (2)

Test Board Design (Servizio Elettronica INFN Perugia)

- PCB design and assembly
- Firmware design capabilities (FPGA and Programmable device)

Facilities (3)

- **Total dose tests**

Co60 gamma rays

- ENEA Casaccia (Rome-Italy)
- Taek SANAEM (Ankara-Turkey)
- GIF UCL (Louvain-la neuve- Belgium)

X-rays

- X-ray tube in SERMS (Terni-Italy)

- **SEE test with ions and protons**

Ions and protons

- INFN LNS Catania (Italy) (ions and protons)
- GSI (Darmstadt- Germany) (ions)
- HIF UCL (Louvain-la neuve- Belgium) (ions)

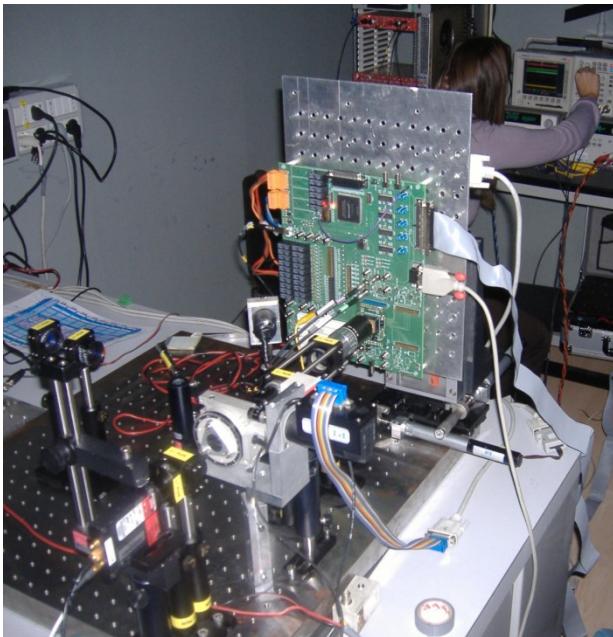
Laser

- MAPRAD (Perugia) Italy

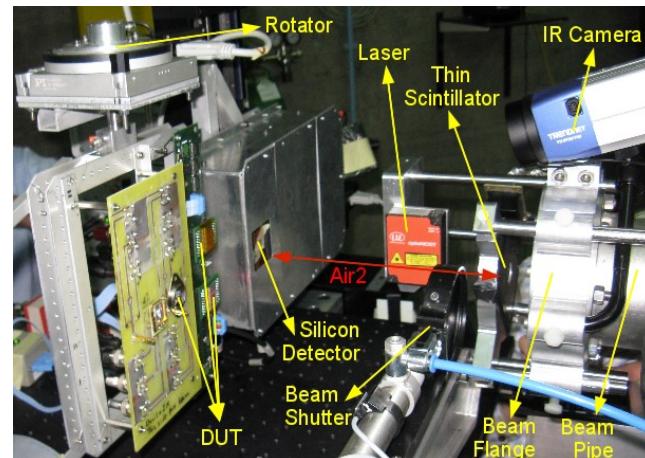
- **Displacement Damage**

- INFN LNS Catania (Italy) (protons)

Facilities (4)



Laser for SEE testing at MAPRad



SEE testing flux measurement setup at LNS



Cobalt source in Casaccia Rome